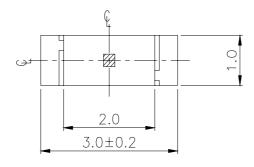
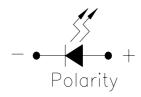
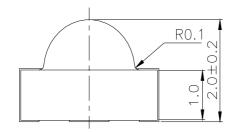


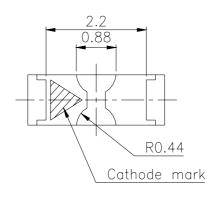
#### **Package Outline Dimensions**

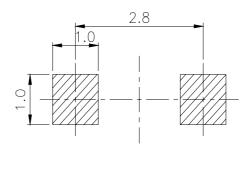






For reflow soldering (propose)





Rev.1

Page: 2 of 9

**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com



**Absolute Maximum Ratings (Ta=25°C)** 

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_{R}$	5	V	
Forward Current	$I_{\mathrm{F}}$	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$ C	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	2000	V	
Power Dissipation	$P_d$	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	$I_{\mathrm{FP}}$	60	mA	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec.  Hand Soldering : 350 °C for 3 sec.		

**Electro-Optical Characteristics (Ta=25°C)** 

Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition	
		A2	19	26				
Luminous Intensity	Iv	A3	26	35		mcd		
		A4	35	41				
Viewing Angle	2 \theta 1/2			120		deg	I <sub>F</sub> =20mA	
Peak Wavelength	λр			591		nm		
Dominant Wavelength	λd			589		nm	IF=ZUINA	
Spectrum Radiation Bandwidth	Δλ			15		nm		
Forward Voltage	VF			2.0	2.4	V		
Reverse Current	IR				10	μΑ	V <sub>R</sub> =5V	

# \*12-21UYC/S530<u>-XX/</u>TR8



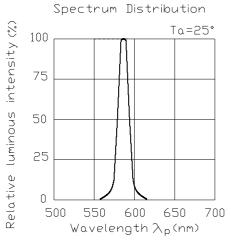
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 9

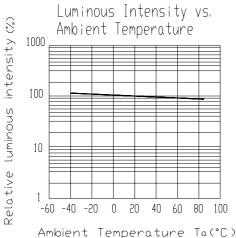


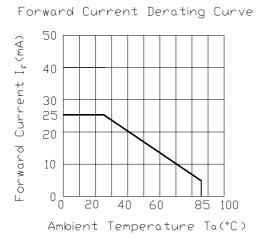
# EVERLIGHT ELECTRONICS CO.,LTD.

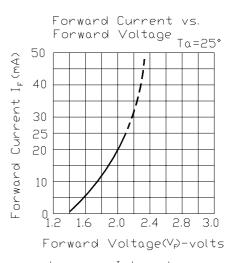
### 12-21UYC/S530-XX/TR8

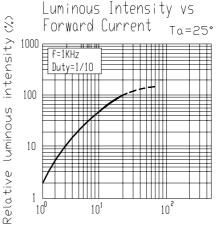
#### **Typical Electro-Optical Characteristics Curves**

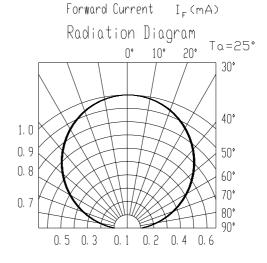












Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 9



## Label explanation

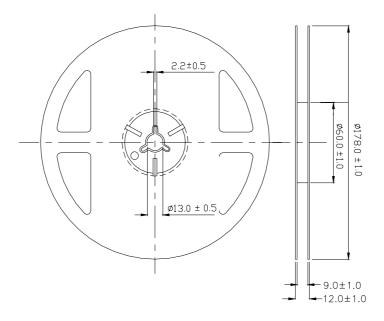
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**

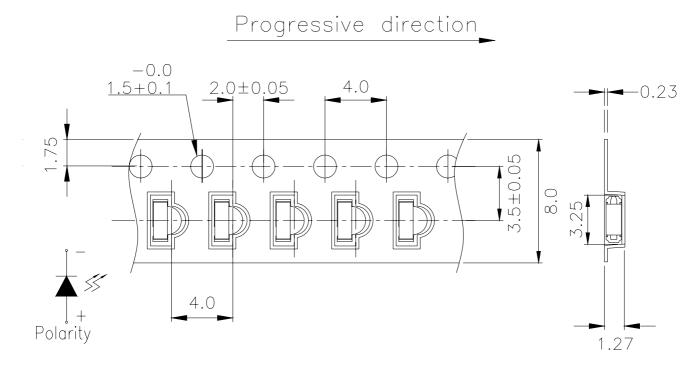


**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 9

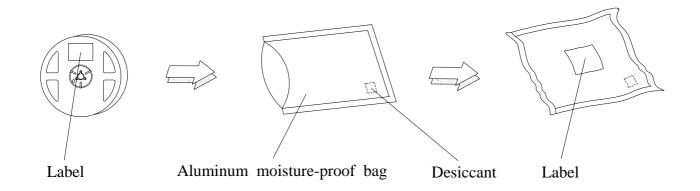


## Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

### **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd. Device No. : SZDSE-121-017 http://www.everlight.com

Rev.1

Page: 6 of 9

Prepared date: 18-Aug-2005

Prepared by:Meng Yali



#### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition Test Hours/Cycles		Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5sec. 6 Min.		22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min  ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 7 of 9



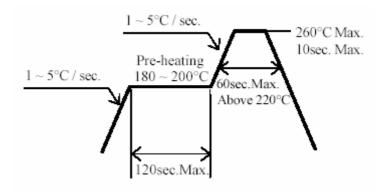
#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 9

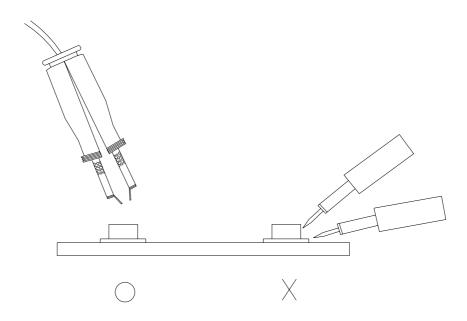


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 9